

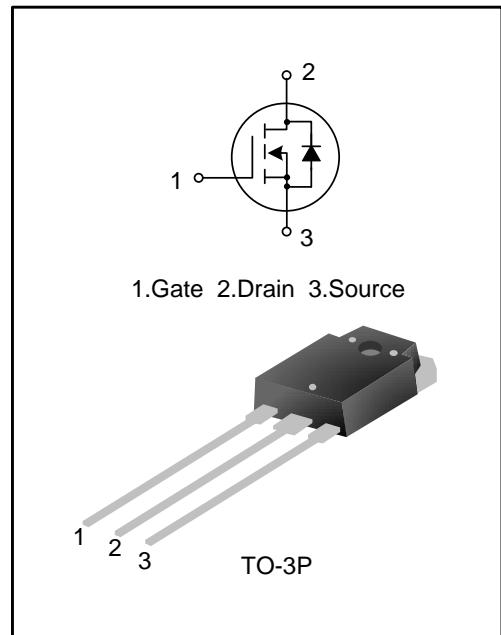
## 23A 500V N-CHANNEL MOSFET

### GENERAL DESCRIPTION

SVF23N50PN is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan proprietary F-Cell™ structure VDMOS technology. The improved planar stripe cell and the improved guard ring terminal have been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are widely used in AC-DC power suppliers, DC-DC converters and H-bridge PWM motor drivers.

### FEATURES

- 23A, 500V,  $R_{DS(on(ty))}=0.21\Omega @ V_{GS}=10V$
- Low gate charge
- Low Crss
- Fast switching
- Improved dv/dt capability



### ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SVF23N50PN	TO-3P	23N50	Pb free	Tube



## ABSOLUTE MAXIMUM RATINGS ( $T_c=25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Characteristics		Symbol	Rating	Unit
Drain-Source Voltage		$V_{DS}$	500	V
Gate-Source Voltage		$V_{GS}$	$\pm 30$	V
Drain Current	$T_c=25^\circ\text{C}$	$I_D$	23.0	A
	$T_c=100^\circ\text{C}$		14.55	
Drain Current Pulsed		$I_{DM}$	92.0	A
Power Dissipation( $T_c=25^\circ\text{C}$ ) -Derate above $25^\circ\text{C}$		$P_D$	280	W
			2.24	$\text{W}/^\circ\text{C}$
Single Pulsed Avalanche Energy (Note 1)		$E_{AS}$	2044	mJ
Operation Junction Temperature Range		$T_J$	-55~+150	$^\circ\text{C}$
Storage Temperature Range		$T_{stg}$	-55~+150	$^\circ\text{C}$

## THERMAL CHARACTERISTICS

Characteristics	Symbol	Rating	Unit
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	0.45	$^\circ\text{C}/\text{W}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	50	$^\circ\text{C}/\text{W}$

## ELECTRICAL CHARACTERISTICS ( $T_c=25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Drain -Source Breakdown Voltage	$B_{VDSS}$	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	500	--	--	V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=500\text{V}, V_{GS}=0\text{V}$	--	--	1.0	$\mu\text{A}$
Gate-Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 30\text{V}, V_{DS}=0\text{V}$	--	--	$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{GS}=V_{DS}, I_D=250\mu\text{A}$	2.0	--	4.0	V
Static Drain- Source On State Resistance	$R_{DS(\text{on})}$	$V_{GS}=10\text{V}, I_D=11.5\text{A}$	--	0.21	0.27	$\Omega$
Input Capacitance	$C_{iss}$	$V_{DS}=25\text{V}, V_{GS}=0\text{V}, f=1.0\text{MHz}$	--	2595.8	--	pF
Output Capacitance	$C_{oss}$		--	343.8	--	
Reverse Transfer Capacitance	$C_{rss}$		--	10.1	--	
Turn-on Delay Time	$t_{d(\text{on})}$	$V_{DD}=250\text{V}, R_G=10\Omega, I_D=23.0\text{A}$ (note 2, 3)	--	42.2	--	ns
Turn-on Rise Time	$t_r$		--	79.0	--	
Turn-off Delay Time	$t_{d(\text{off})}$		--	125.7	--	
Turn-off Fall Time	$t_f$		--	71.2	--	
Total Gate Charge	$Q_g$	$V_{DD}=400\text{V}, V_{GS}=10\text{V}, I_D=23.0\text{A}$ (note 2, 3)	--	42.51	--	nC
Gate-Source Charge	$Q_{gs}$		--	12.9	--	
Gate-Drain Charge	$Q_{gd}$		--	14.34	--	

## SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Continuous Source Current	$I_S$	Integral Reverse P-N Junction Diode in the MOSFET	--	--	23.0	A
Pulsed Source Current	$I_{SM}$		--	--	92.0	
Diode Forward Voltage	$V_{SD}$	$I_S=23.0\text{A}, V_{GS}=0\text{V}$	--	--	1.4	V
Reverse Recovery Time	$T_{rr}$	$I_S=23.0\text{A}, V_{GS}=0\text{V},$ $dI_F/dt=100\text{A}/\mu\text{s}(\text{Note 2})$	--	578.21	--	ns
Reverse Recovery Charge	$Q_{rr}$		--	7.89	--	$\mu\text{C}$

**Notes:**

1.  $L=30\text{mH}, I_{AS}=10.65\text{A}, V_{DD}=100\text{V}, R_G=25\Omega$ , starting  $T_J=25^\circ\text{C}$ ;
2. Pulse Test: Pulse width  $\leq 300\mu\text{s}$ , Duty cycle  $\leq 2\%$ ;
3. Essentially independent of operating temperature.

## TYPICAL CHARACTERISTICS

Figure 1. On-Region Characteristics

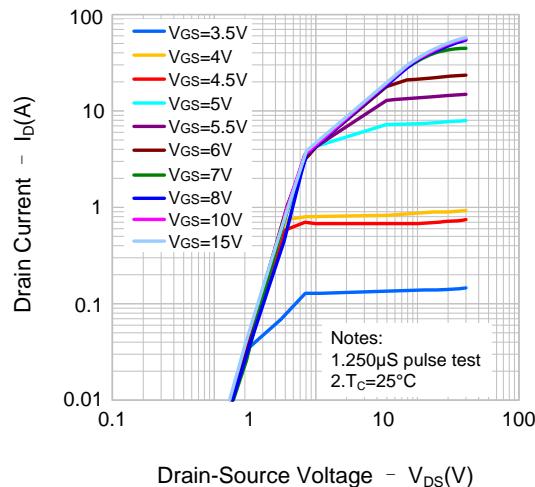


Figure 2. Transfer Characteristics

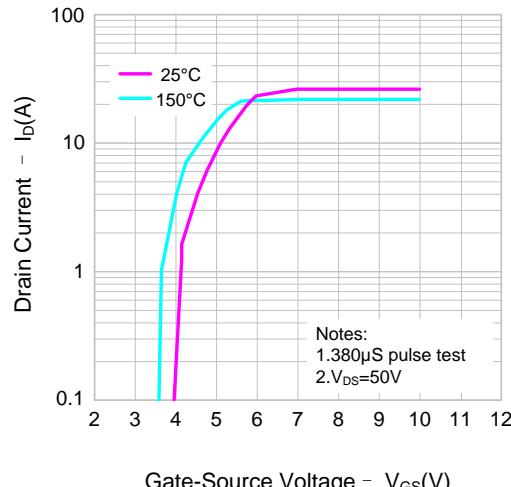


Figure 3. On-Resistance Variation vs.  
Drain Current and Gate Voltage

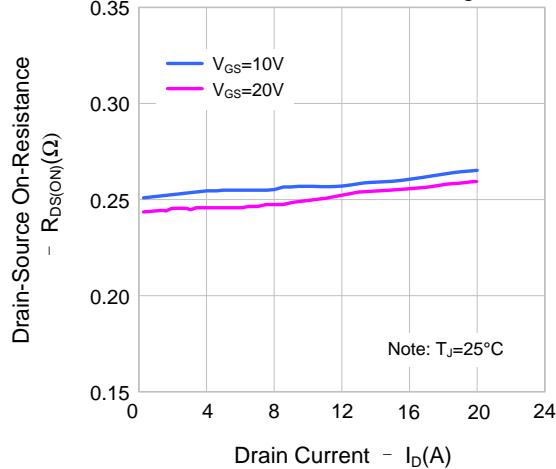
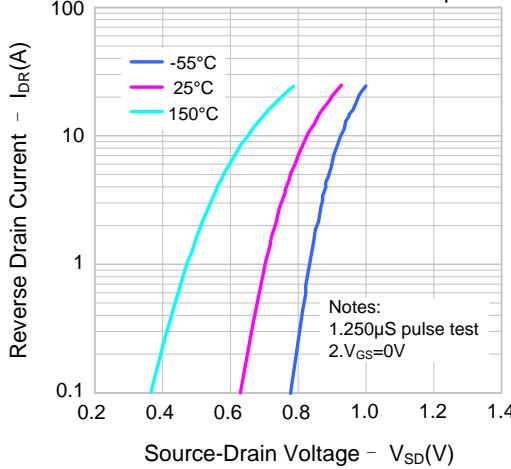
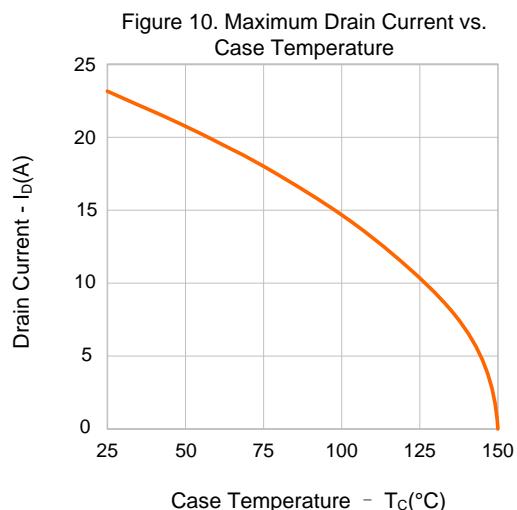
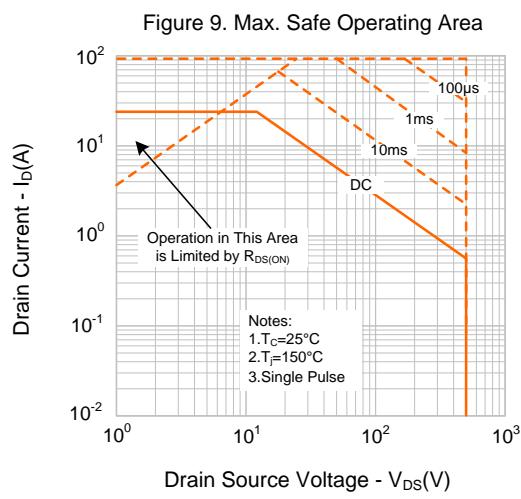
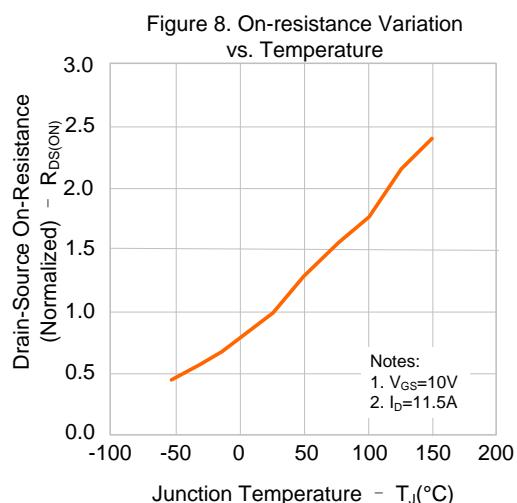
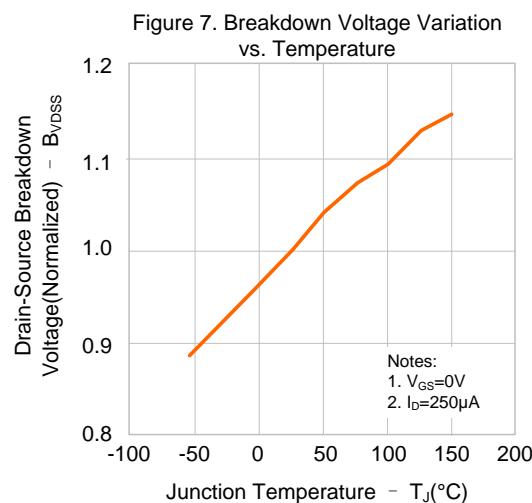
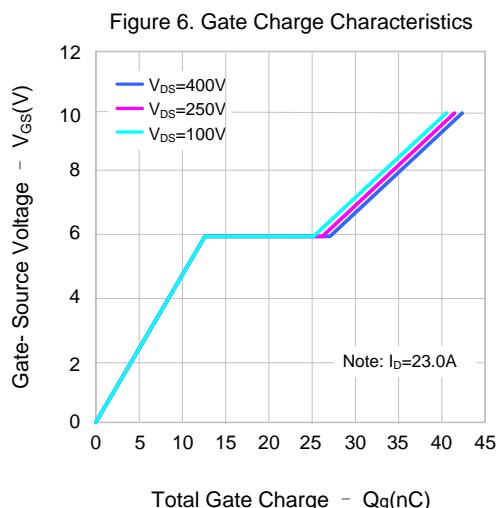
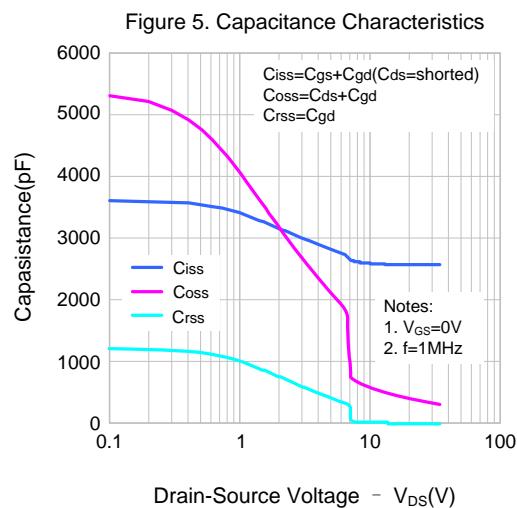


Figure 4. Body Diode Forward Voltage  
Variation vs. Source Current and Temperature





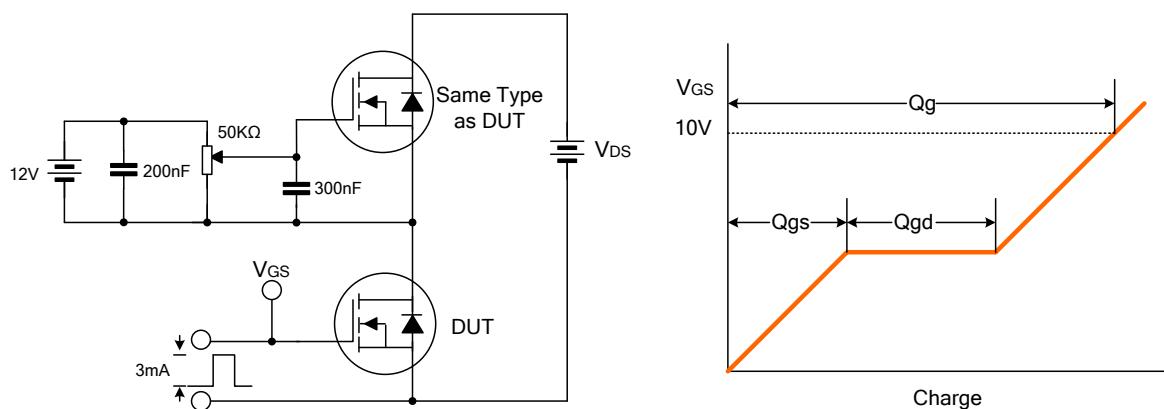
## TYPICAL CHARACTERISTICS(CONTINUED)



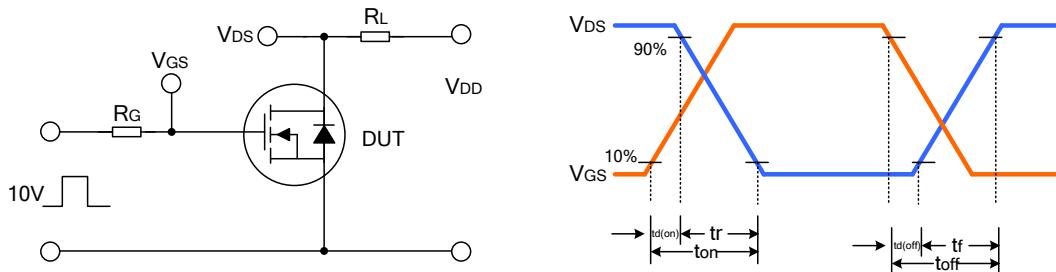


## TYPICAL TEST CIRCUIT

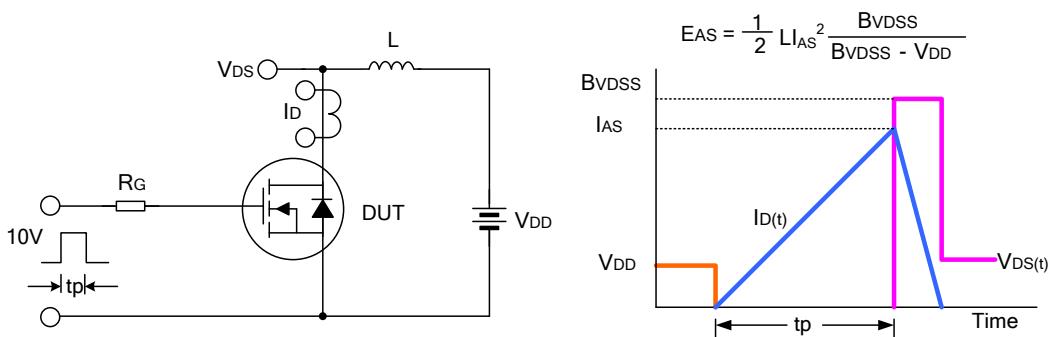
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



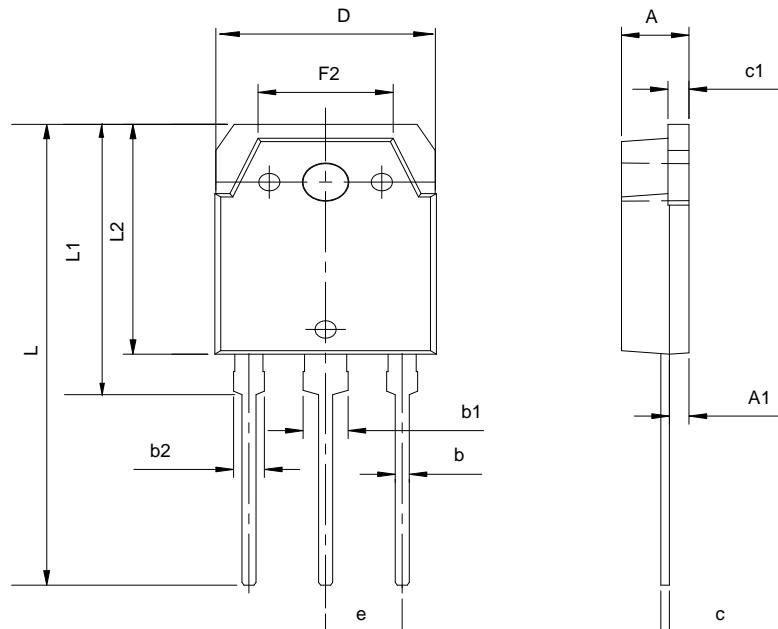
Unclamped Inductive Switching Test Circuit & Waveform





## PACKAGE OUTLINE

TO-3P		UNIT: mm		
SYMBOL	MILLIMETER			
	MIN	NOM	MAX	
A	4.4	—	5.2	
C1	1.2	—	1.8	
A1	1.2	—	2.0	
b	0.7	1.0	1.3	
b1	2.7	3.0	3.3	
b2	1.7	2.0	2.3	
D	15.0	15.5	16.0	
C	0.4	0.6	0.8	
F2	8.5	—	10.0	
e	5.45 TYP			
L1	22.6	—	23.6	
L	39.0	—	41.5	
L2	19.5	—	21.0	



### Important notice :

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Rev.: 1.2

Revision History:

1. Deleted NOMENCLATURE
  2. Modify Important notice
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Rev.: 1.1

Revision History:

1. Modify ordering information
  2. Modify Part No.
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Rev.: 1.0

Revision History:

1. First release
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